

## Low Voltage, 0.6 $\Omega$ , Dual SPDT Analog Switch

### DESCRIPTION

The DG2735, DG2736 are low voltage, low on-resistance, dual single-pole/double-throw (SPDT) monolithic CMOS analog switches designed for high performance switching of analog signals. Combining low-power, high speed, low on-resistance, and small package size, the DG2735, DG2736 are ideal for portable and battery power applications.

The DG2735, DG2736 have an operation range from 1.65 V to 4.3 V single supply. The DG2735 has two separate control pins with for the separated two SPDT switched. The DG2736 has an EN pin. All switches are at high impedance mode when the EN is high.

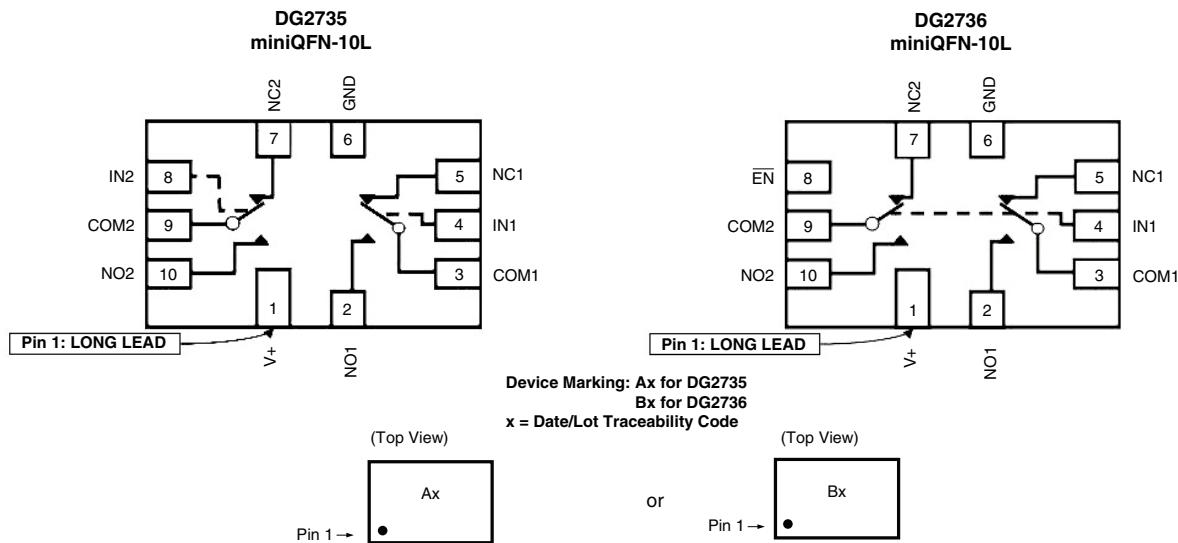
The DG2735, DG2736 are guaranteed 1.65 V logic compatible, allowing the easy interface with low voltage DSP or MCU control logic and ideal for one cell Li-ion battery direct power.

The switch conducts signals within power rails equally well in both directions when on, and blocks up to the power supply level when off. Break-before-make is guaranteed.

The DG2735, DG2736 are built on Vishay Siliconix's sub micron CMOS low voltage process technology and provides greater than 300 mA latch-up protection, as tested per JESD78.

As a committed partner to the community and the environment, Vishay Siliconix manufactures this product with lead (Pb)-free device terminations. DG2735, DG2736 are offered in a miniQFN package. The miniQFN package has a nickel-palladium-gold device termination and is represented by the lead (Pb)-free “-E4” suffix. The nickel-palladium-gold device terminations meet all JEDEC standards for reflow and MSL ratings.

### FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION



### FEATURES

- Low voltage operation (1.65 V to 4.3 V)
- Low on-resistance -  $R_{ON}$ : 0.6  $\Omega$  at 2.7 V
- Fast switching:  $t_{ON} = 55$  ns at 2.7 V
- $T_{OFF} = 40$  ns at 2.7 V
- Latch-up current > 300 mA (JESD78)
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
**HALOGEN**  
**FREE**

### BENEFITS

- Reduced power consumption
- High accuracy
- Reduce board space
- TTL/1.65 V logic compatible

### APPLICATIONS

- Cellular phones
- Speaker headset switching
- Audio and video signal routing
- PCMCIA cards
- Battery operated systems
- Portable media player Handheld test instruments

Note: Pin 1 has long lead

# DG2735, DG2736

Vishay Siliconix



TRUTH TABLE			
Logic	EN (DG2736 only)	NC1, 2	NO1, 2
0	1	OFF	OFF
1	1	OFF	OFF
0	0	ON	OFF
1	0	OFF	ON

ORDERING INFORMATION		
Temp. Range	Package	Part Number
- 40 °C to 85°C	miniQFN10	DG2735DN-T1-E4 DG2736DN-T1-E4

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C, unless otherwise noted)			
Parameter	Symbol	Limit	Unit
Reference to GND	V+	- 0.3 to 5	V
	IN, COM, NC, NO <sup>a</sup>	- 0.3 to (V+ + 0.3)	
Current (Any terminal except NO, NC or COM)		30	mA
Continuous Current (NO, NC, or COM)		± 250	
Peak Current (Pulsed at 1 ms, 10 % duty cycle)		± 500	
Storage Temperature (D Suffix)		- 65 to 150	°C
Power Dissipation (Packages) <sup>b</sup>	miniQFN10 <sup>c</sup>	208	mW

Notes:

- a. Signals on NC, NO, or COM or IN exceeding V+ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- b. All leads welded or soldered to PC board.
- c. Derate 4 mW/C above 70 °C.

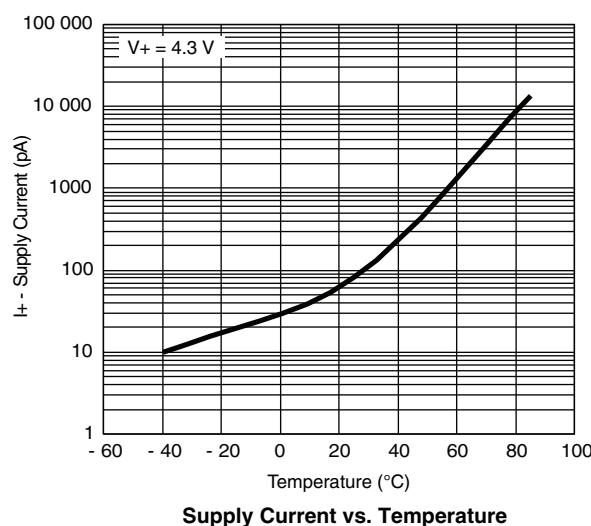
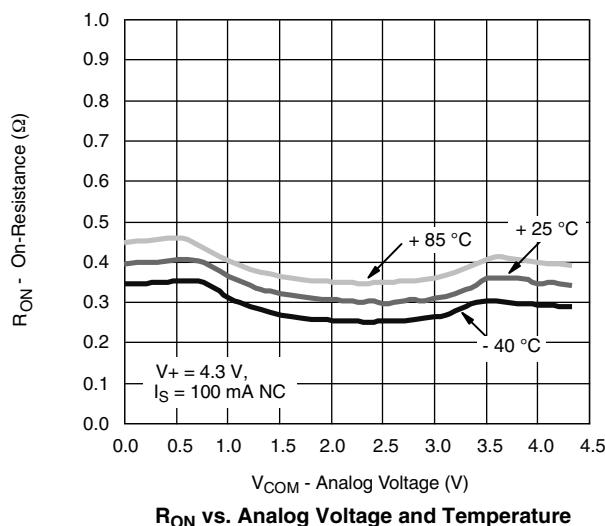
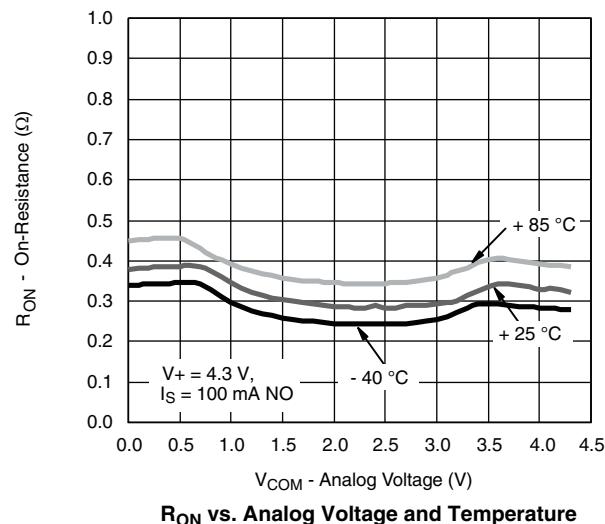
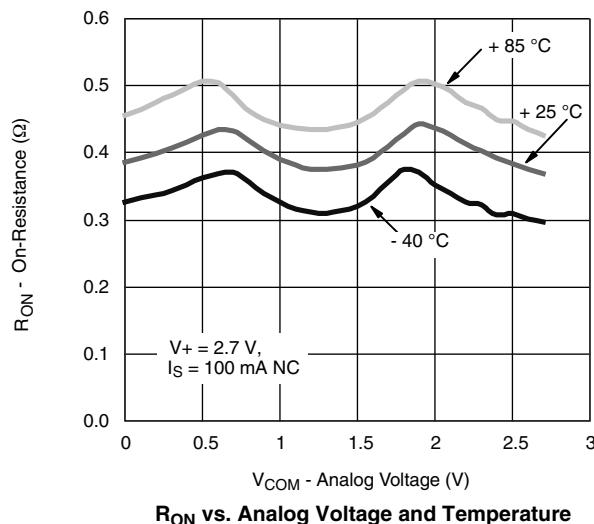
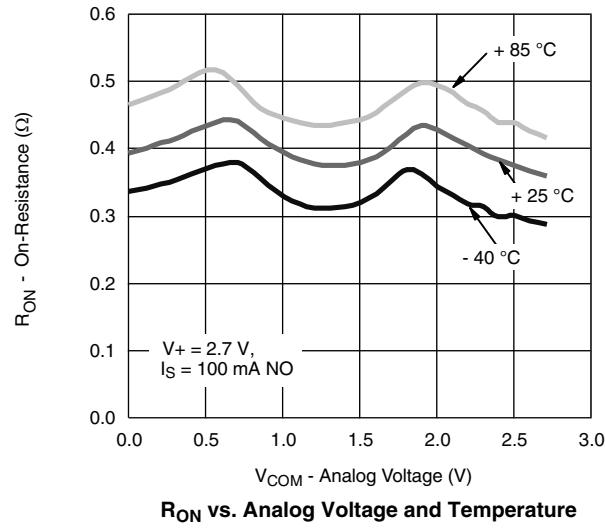
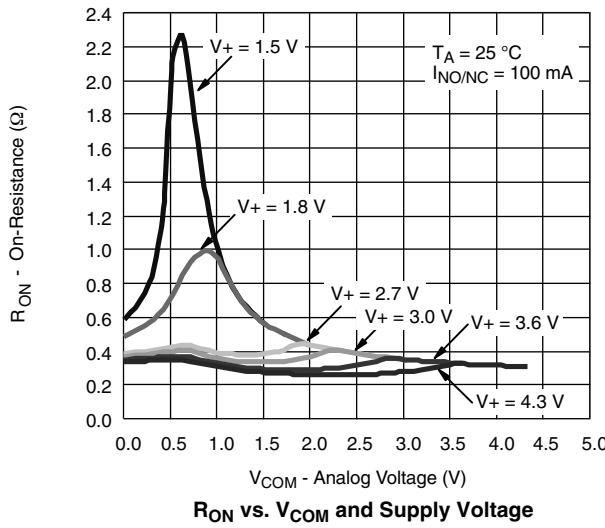
SPECIFICATIONS (V+ = 3 V)								
Parameter	Symbol	Test Conditions Unless Otherwise Specified V+ = 3 V, ± 10 %, V <sub>IN</sub> = 0.4 V or 1.65 V <sup>e</sup>	Temp. <sup>a</sup>	Limits			Unit	
				Min. <sup>b</sup>	Typ. <sup>c</sup>	Max. <sup>b</sup>		
Analog Switch								
On-Resistance	R <sub>DS(on)</sub>	R <sub>DS(on)</sub>	Full	0		V+	V	
		V+ = 2.7 V, I <sub>NO/NC</sub> = 100 mA, V <sub>COM</sub> = 0.5 V	Room		0.5	0.6	Ω	
		V+ = 2.7 V, I <sub>NO/NC</sub> = 100 mA, V <sub>COM</sub> = 1.5 V			0.5			
		V+ = 2.7 V, I <sub>NO/NC</sub> = 100 mA, V <sub>COM</sub> = 0.5 V	Full		0.4	0.5		
		V+ = 2.7 V, I <sub>NO/NC</sub> = 100 mA, V <sub>COM</sub> = 1.5 V			0.3			
		V+ = 4.3 V, I <sub>NO/NC</sub> = 100 mA, V <sub>COM</sub> = 0.9 V	Room		0.4	0.5		
		V+ = 4.3 V, I <sub>NO/NC</sub> = 100 mA, V <sub>COM</sub> = 2.5 V			0.3			
		V+ = 4.3 V, I <sub>NO/NC</sub> = 100 mA, V <sub>COM</sub> = 0.9 V	Full		0.5			
R <sub>ON</sub> Match <sup>d</sup>	ΔR <sub>ON</sub>	V+ = 2.7 V, I <sub>NO/NC</sub> = 100 mA, V <sub>COM</sub> = 0.5 V, 1.5 V	Room		0.06	0.08		
		V+ = 4.3 V, I <sub>NO/NC</sub> = 100 mA, V <sub>COM</sub> = 0.9 V, 2.5 V						
R <sub>ON</sub> resistance flatness <sup>d</sup>	R <sub>ON</sub> flatness	V+ = 2.7 V, I <sub>NO/NC</sub> = 100 mA, V <sub>COM</sub> = 0.5 V, 1.5 V	Room			0.15		
Switch Off Leakage Current	I <sub>NO/NC(off)</sub>	V+ = 4.3 V, V <sub>NO/NC</sub> = 0.3 V/4 V, V <sub>COM</sub> = 4 V/0.3 V	Room	- 2		2	nA	
			Full	- 10		10		
	I <sub>COM(off)</sub>		Room	- 2		2		
			Full	- 10		10		
Channel-On Leakage Current	I <sub>COM(on)</sub>	V+ = 4.3 V, V <sub>NO/NC</sub> = V <sub>COM</sub> = 4 V/0.3 V	Room	- 5		5		
			Full	- 20		20		

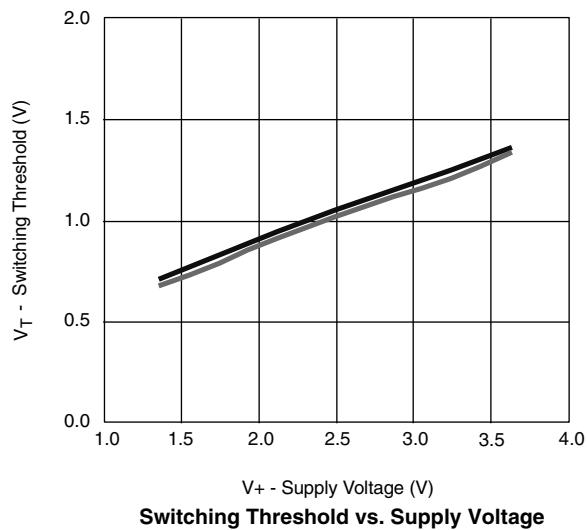
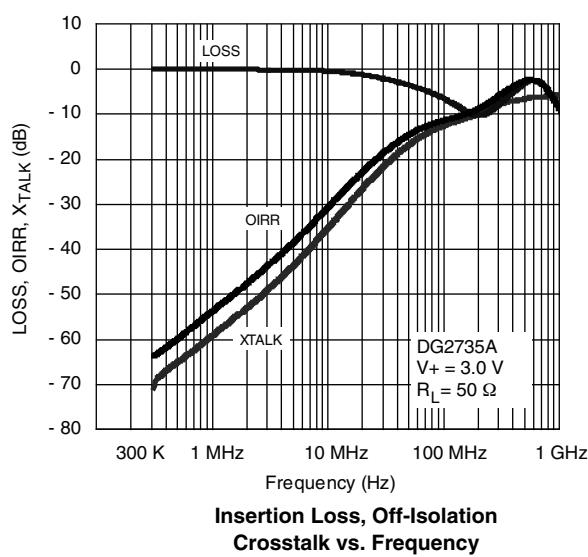
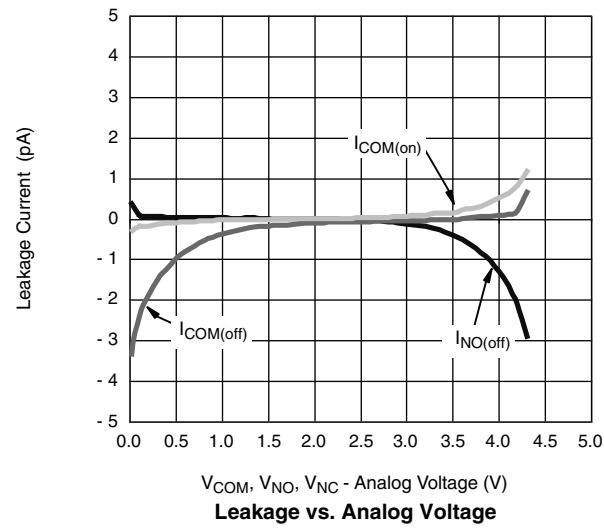
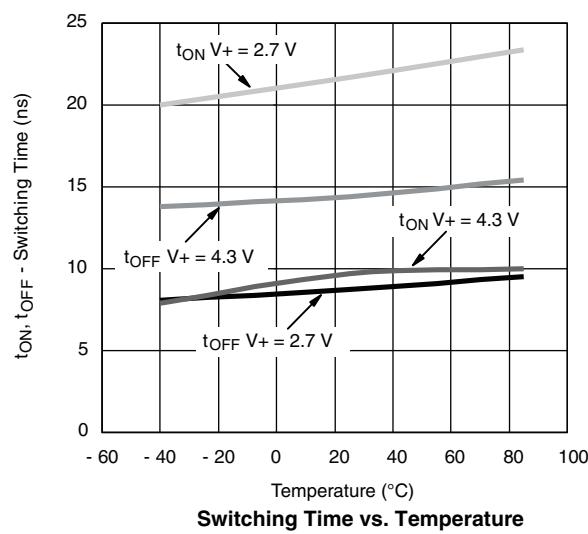
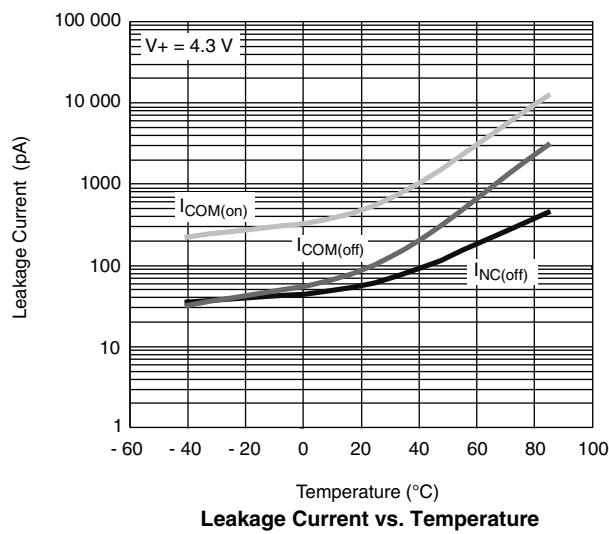
<b>SPECIFICATIONS</b> (V <sub>+</sub> = 3 V)								
Parameter	Symbol	Test Conditions Unless Otherwise Specified		Temp. <sup>a</sup>	Limits			Unit
		V <sub>+</sub> = 3 V, ± 10 %, V <sub>IN</sub> = 0.4 V or 1.65 V <sup>e</sup>			Min. <sup>b</sup>	Typ. <sup>c</sup>	Max. <sup>b</sup>	
<b>Digital Control</b>								
Input High Voltage	V <sub>INH</sub>			Full	1.65			V
Input Low Voltage	V <sub>INL</sub>			Full			0.4	
Input Capacitance	C <sub>IN</sub>			Full		6		pF
Input Current	I <sub>INL</sub> or I <sub>INH</sub>	V <sub>IN</sub> = 0 or V <sub>+</sub>		Full	- 1		1	µA
<b>Dynamic Characteristics</b>								
Break-Before-Make Time <sup>e</sup>	t <sub>BBM</sub>	V <sub>+</sub> = 3.6 V, V <sub>NO</sub> , V <sub>NC</sub> = 1.5 V, R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 35 pF	Room	Room	1	5		ns
Turn-On Time <sup>e</sup>	t <sub>ON</sub>			Room		50	78	
Turn-Off Time <sup>e</sup>	t <sub>OFF</sub>			Full			80	
Enable Turn-On Time <sup>e</sup> DG2736 (EN)	t <sub>ON(EN)</sub>			Room		35	58	
Enable Turn-Off Time <sup>e</sup> DG2736 (EN)	t <sub>OFF(EN)</sub>			Full		60		
Off-Isolation <sup>d</sup>	O <sub>IRR</sub>			Room	50	78		
Crosstalk <sup>d</sup>	X <sub>TALK</sub>			Full		80		
3dB bandwith <sup>d</sup>				Room	35	58		
NO, NC Off Capacitance <sup>d</sup>	C <sub>NO(off)</sub> C <sub>NC(off)</sub>		R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 5 pF, f = 100 kHz	Room	Full	60		dB
Channel On Capacitance <sup>d</sup>	C <sub>NO(on)</sub> C <sub>NC(on)</sub>			Room		- 70		
				Room		- 70		
				Room	50			MHz
<b>Power Supply</b>								
Power Supply Range	V <sub>+</sub>				1.65		4.3	V
Power Supply Current	I <sub>+</sub>	V <sub>IN</sub> = 0 or V <sub>+</sub>		Full			1	µA

**Notes:**

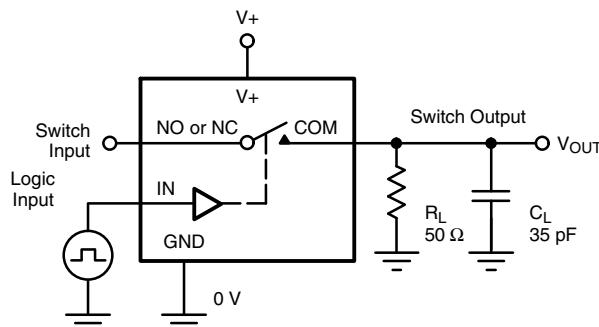
- Room = 25 °C, Full = as determined by the operating suffix.
- The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- Typical values are for design aid only, not guaranteed nor subject to production testing.
- Guarantee by design, not subjected to production test.
- V<sub>IN</sub> = input voltage to perform proper function.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

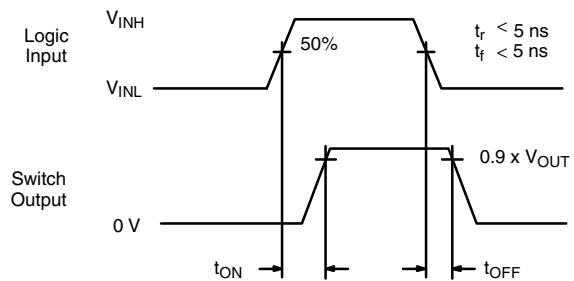
TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)

**TYPICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)


## TEST CIRCUITS



$$V_{OUT} = V_{COM} \left( \frac{R_L}{R_L + R_{ON}} \right)$$



Logic "1" = Switch On  
Logic input waveforms inverted for switches that have the opposite logic sense.

Figure 1. Switching Time

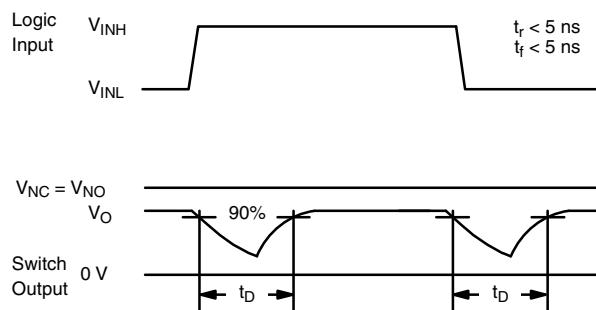
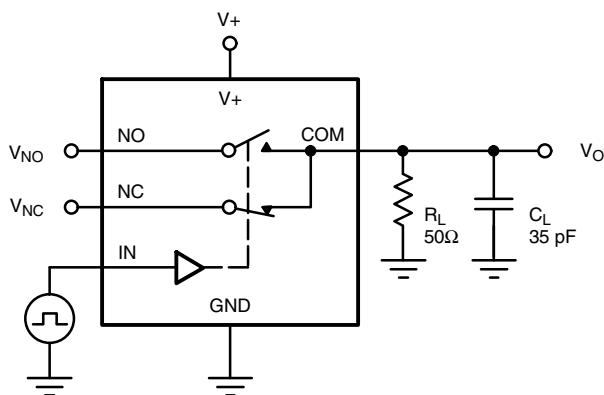
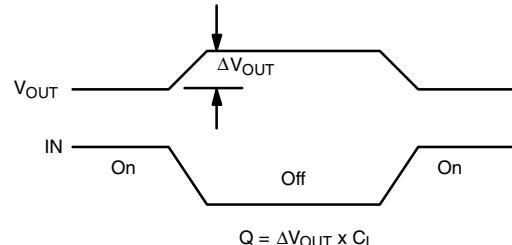
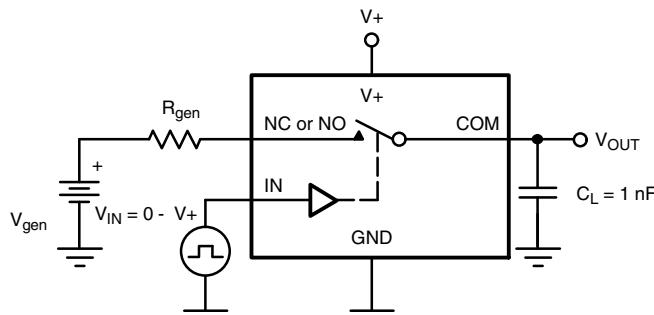
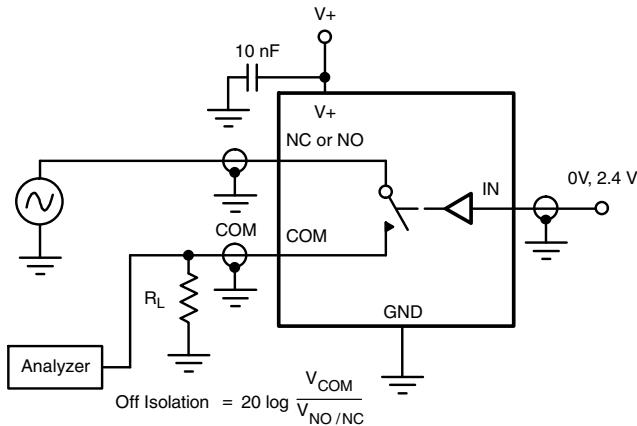


Figure 2. Break-Before-Make Interval

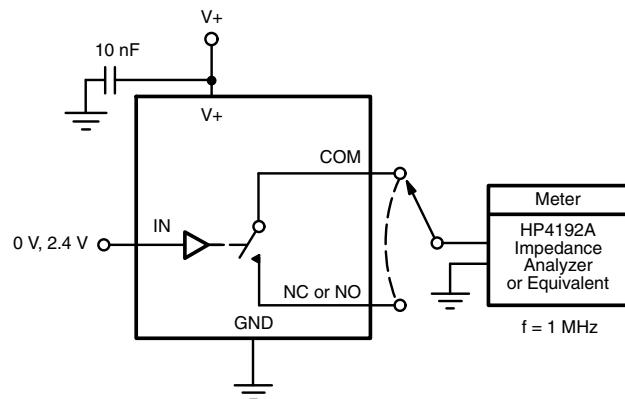
**TEST CIRCUITS**


IN depends on switch configuration: input polarity determined by sense of switch.

**Figure 3. Charge Injection**



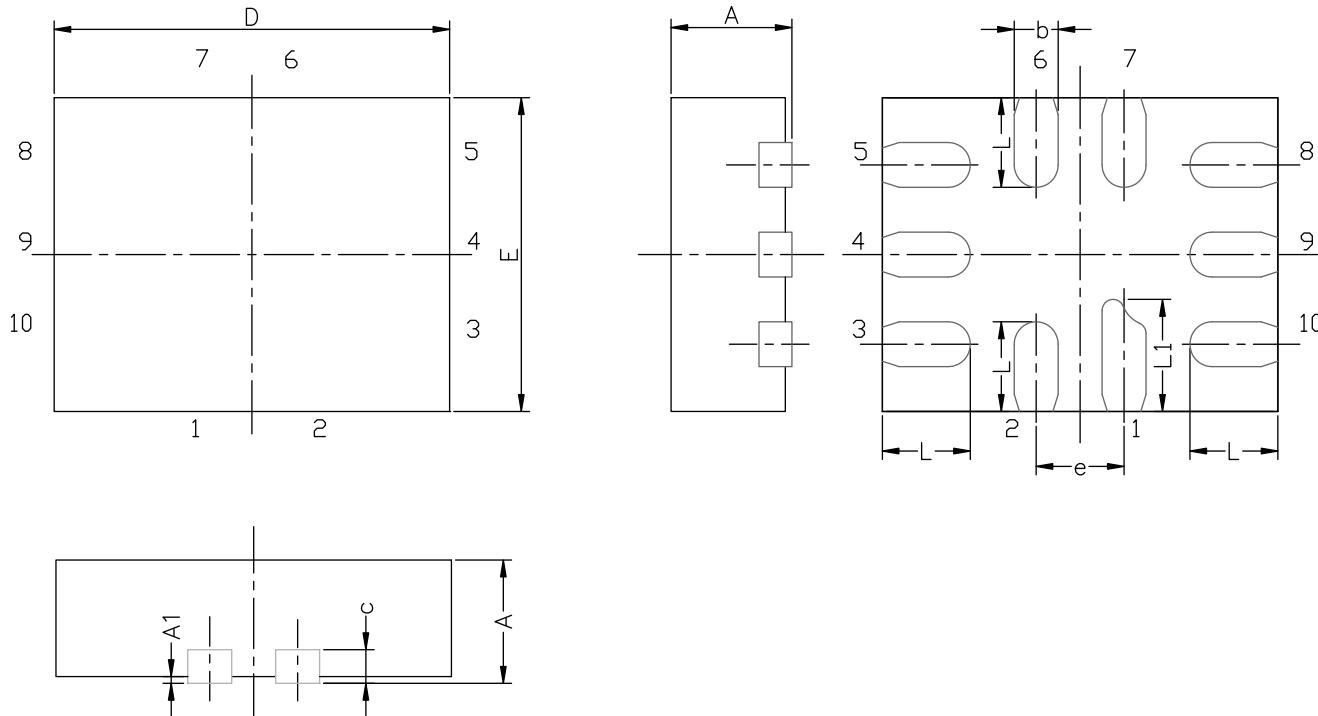
**Figure 4. Off-Isolation**



**Figure 5. Channel Off/On Capacitance**

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see [www.vishay.com/ppg?74420](http://www.vishay.com/ppg?74420).

## MINI QFN-10L CASE OUTLINE



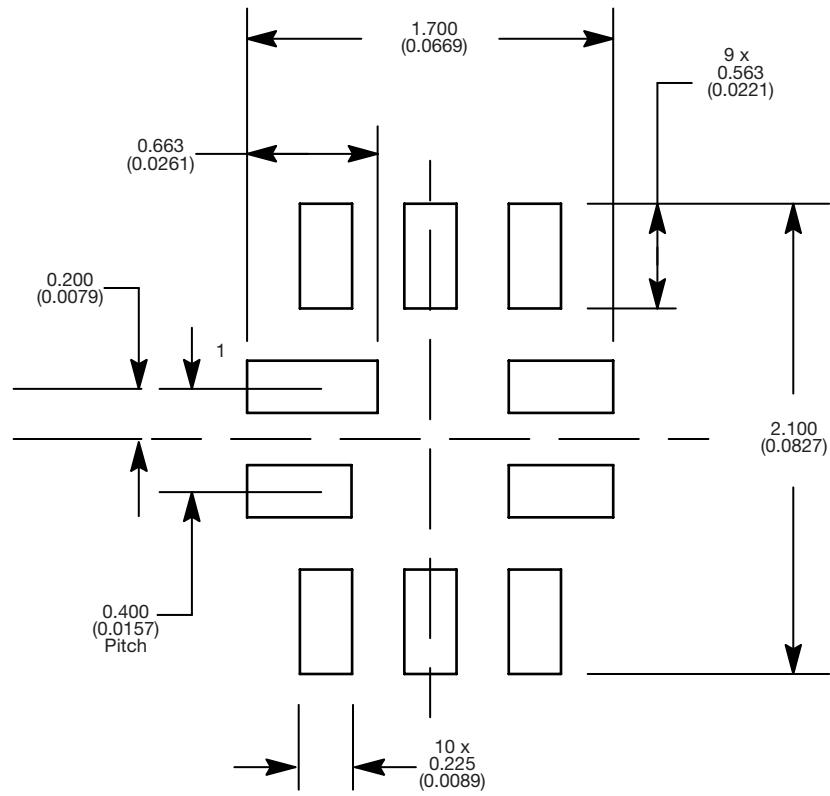
DIM	MILLIMETERS			INCHES		
	MIN.	NAM.	MAX.	MIN.	NAM.	MAX.
A	0.45	0.55	0.60	0.0177	0.0217	0.0236
A1	0.00	-	0.05	0.000	-	0.002
b	0.15	0.20	0.25	0.006	0.008	0.010
c	0.150 or 0.127 REF <sup>(1)</sup>			0.006 or 0.005 REF <sup>(1)</sup>		
D	1.70	1.80	1.90	0.067	0.071	0.075
E	1.30	1.40	1.50	0.051	0.055	0.059
e	0.40 BSC			0.016 BSC		
L	0.35	0.40	0.45	0.014	0.016	0.018
L1	0.45	0.50	0.55	0.0177	0.0197	0.0217

**Note**

<sup>(1)</sup> The dimension depends on the leadframe that assembly house used.

 ECN T16-0163-Rev. B, 16-May-16  
 DWG: 5957

### RECOMMENDED MINIMUM PADS FOR MINI QFN 10L



Mounting Footprint  
Dimensions in mm (inch)

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